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\*\* CONTINUING DATA \*\*\*\*\* NONE ✓

\*\* FOREIGN APPLICATIONS \*\*\*\*\* YR ✓

IF REQUIRED, FOREIGN FILING LICENSE GRANTED \*\*  
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Foreign Priority claimed 35 USC 119 (a-d) conditions met Verified and Acknowledged	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Allowance Examiner's Signature _____ Initials _____	STATE OR COUNTRY TAIWAN	SHEETS DRAWING 3	TOTAL CLAIMS 38	INDEPENDENT CLAIMS 2
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## ADDRESS

54657

## TITLE

Surface treated low-k dielectric as diffusion barrier for copper metallization

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